# CMSA65R280Q



#### **General Description**

The 65R280Q is power MOSFET using Cmos's advanced super junction technology that can realize very low on resistance and gate charge. It will provide much high efficiency by using optimized charge coupling technology. These user friendly devices give an advantage of low EMI to designers as well as low switching loss.

## **N-Channel Super Junction Power MOSFET**

## **Product Summary**

BVDSS	RDSON	ID
650V	0.3Ω	14A

### Applications

- LCD & PDP TV
- Adaptor
- UPS

## DFN-8 5x6 Pin Configuration



Туре	Package	Marking
CMSA65R280Q	DFN-8 5*6	CMSA65R280Q

## Features

- Low On-Resistance
- 100% avalanche tested

Absolute Maximum Ratings

• ROHS compliant

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage 650		V
V <sub>GS</sub>	Gate-Source Voltage	±30	V
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current	14	А
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current 11		А
I <sub>DM</sub>	Pulsed Drain Current	56	А
EAS	Single Pulse Avalanche Energy <sup>1</sup>	360	mJ
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation	57	W
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	150	°C

## **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit	
R <sub>0JA</sub>	Thermal Resistance Junction-ambient		59	°C/W	
$R_{ extsf{ heta}JC}$	Thermal Resistance Junction -Case		2.2	°C/W	



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## **N-Channel Super Junction Power MOSFET**

## Electrical Characteristics (T<sub>J</sub>=25 $^{\circ}$ C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	650			V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS}$ =10V , $I_{D}$ =6A			0.3	Ω
V <sub>GS(th)</sub>	Gate Threshold Voltage	Vos= Vgs, Id = 250µA	2		4	V
I <sub>DSS</sub>	Drain-Source Leakage Current	$V_{\text{DS}}\text{=}650V$ , $V_{\text{GS}}\text{=}0V$ , $T_{\text{J}}\text{=}25^\circ\!\!\mathbb{C}$			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm30V$ , $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =20V, I <sub>D</sub> =6A		10		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		23		Ω
Qg	Total Gate Charge			30		
Q <sub>gs</sub>	Gate-Source Charge	$V_{DS}$ =520V, $V_{GS}$ =10V, $I_{D}$ =14A		7.1		nC
Q <sub>gd</sub>	Gate-Drain Charge			10		
T <sub>d(on)</sub>	Turn-On Delay Time			25		
Tr	Rise Time	$V_{DD}$ =325V, $R_{G}$ =25 $\Omega$		60		20
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =14A		150		115
T <sub>f</sub>	Fall Time	V <sub>GS</sub> = 10V		52		
C <sub>iss</sub>	Input Capacitance			1100		
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =25V ,V <sub>GS</sub> =0V , f=1MHz		1200		pF
Crss	Reverse Transfer Capacitance			70		

#### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current	$V_G=V_D=0V$ , Force Current			14	А
I <sub>SM</sub>	Pulsed Source Current				56	А
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>S</sub> =12A , TJ=25℃			1.2	V

Notes:

1.The EAS data shows Max. rating .The test condition is VDs=50V , VGs=10V , L=20mH , IAs=6A.

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